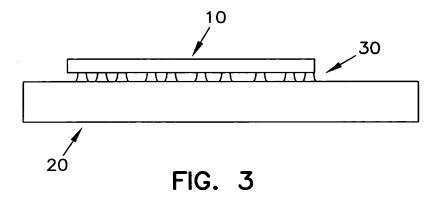
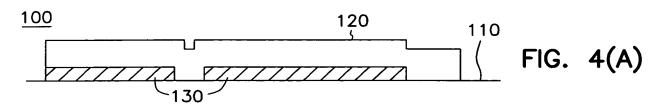
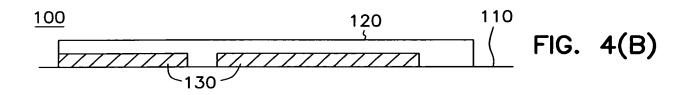


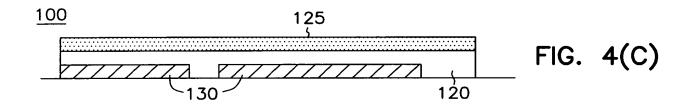
FIG. 2

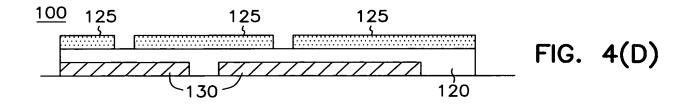


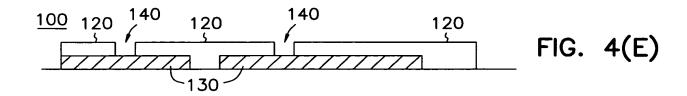
Dkt #: 303.572US2

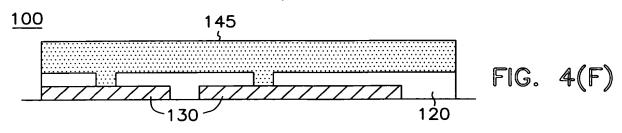


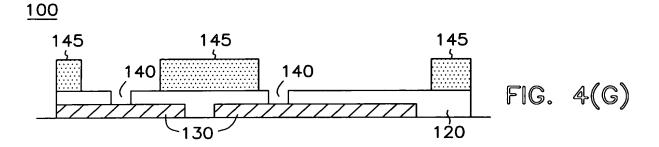


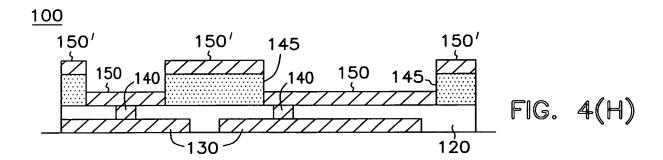


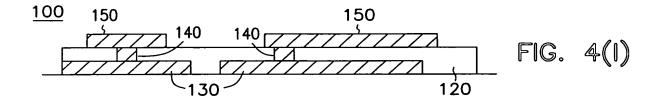


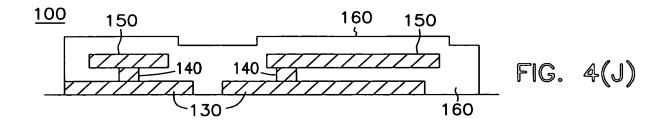






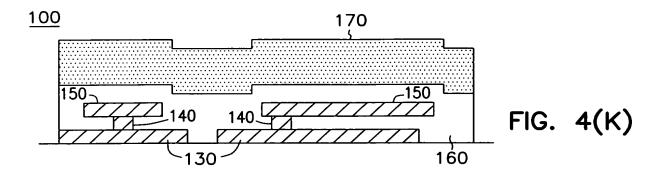


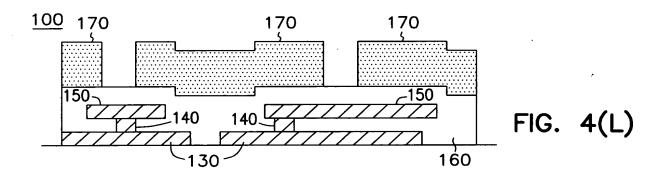


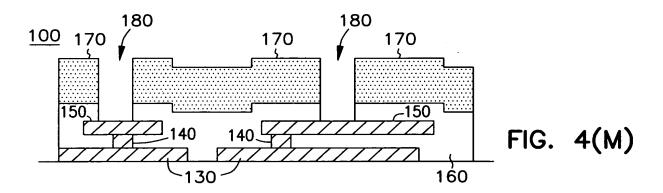


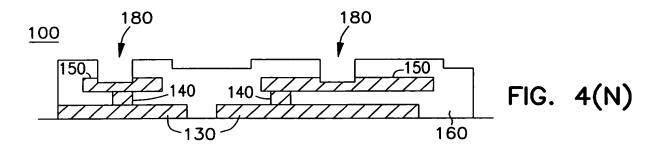
TITLE: SELECTIVE DEPOSITION OF SOLDER BALL CONTACTS INVENTORS NAME: Paul A. Farrar

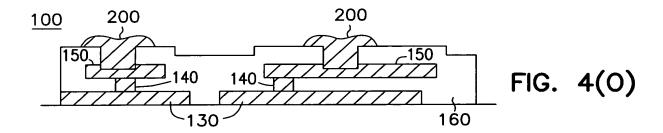
Dkt #: 303.572US2

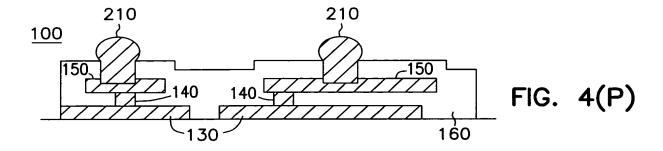


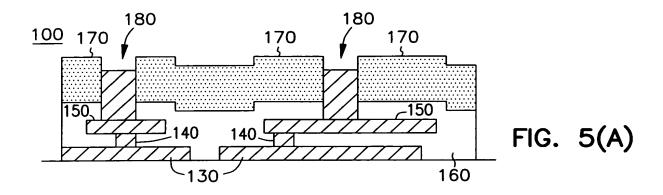


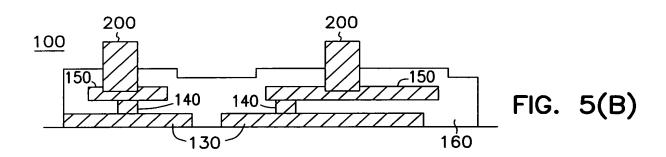


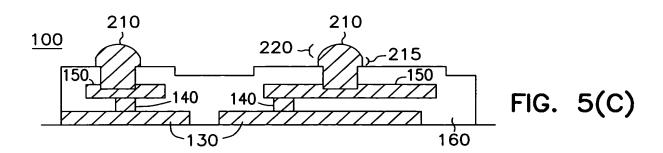


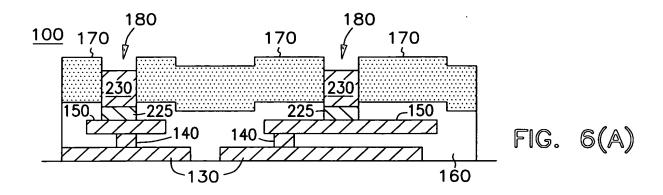


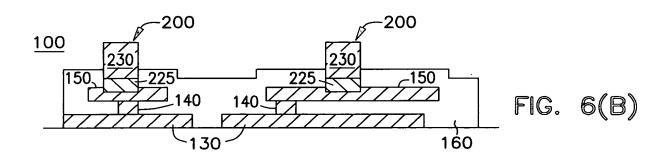


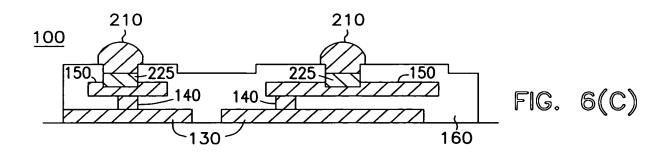


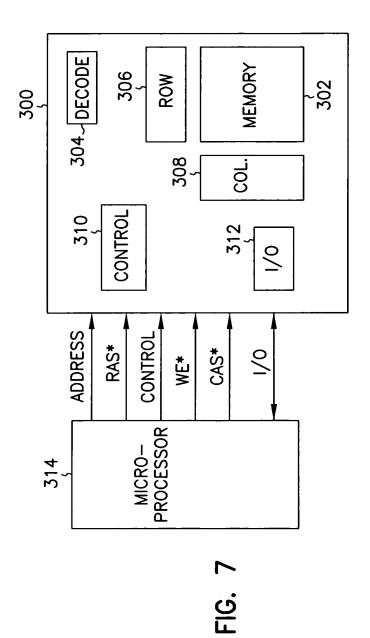


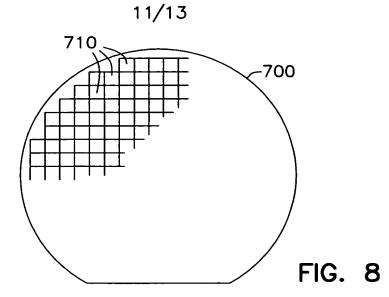


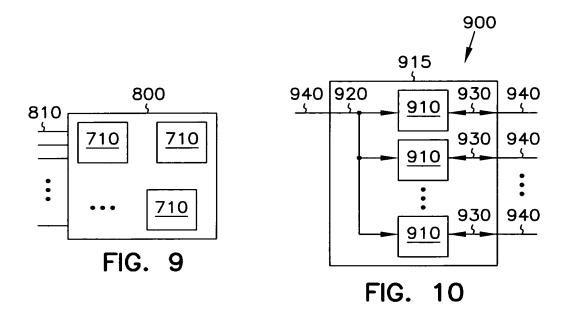


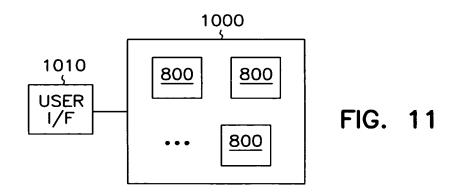


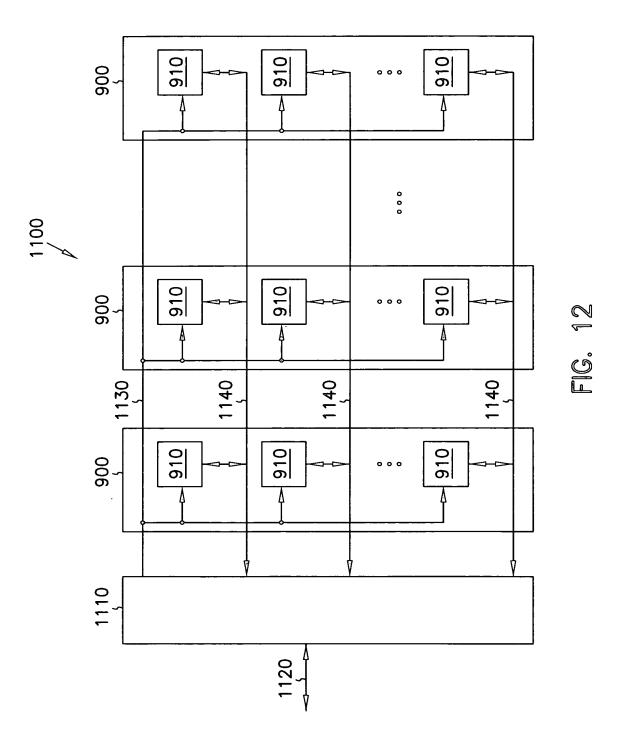












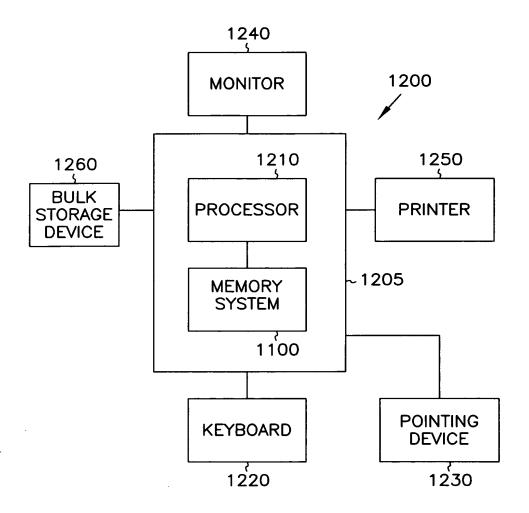


FIG. 13